

Product/process change notification

PCN N° 2023-163-A

Dear customer,

Please find attached our Infineon Technologies AG PCN:

Capacity extension for dedicated Gen10.7 products by introduction of additional wafer manufacturing site at Samsung Electronics Co. Ltd., Korea

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **2024-01-04**
- Infineon aligns with the widely recognized JEDEC STANDARD “**JESD46**“, which stipulates: **“Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”**

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG

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Chairman of the Supervisory Board Dr. Herbert Diess

Management Board Jochen Hanebeck (CEO), Elke Reichart, Dr. Sven Schneider, Andreas Urschitz, Dr. Rutger Wijburg

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- ▶ **Products affected** Please refer to attached affected product list
“pcn_2023-163-A_[customer-no].pdf”

- ▶ **Detailed change information**

Subject	Capacity extension for dedicated Gen10.7 products by introduction of additional wafer manufacturing site at Samsung Electronics Co. Ltd., Korea	
Reason	Extension of wafer manufacturing sites for additional capacity to ensure continuity of supply and flexible manufacturing	
Description	<u>Old</u>	<u>New</u>
Wafer Production Location	<ul style="list-style-type: none"> ■ Newport Wafer Fab Ltd. (NWF Ltd.), United Kingdom ■ Vanguard International Semiconductor Corporation, Taiwan ■ Infineon Technologies Dresden GmbH, Dresden, Germany 	<ul style="list-style-type: none"> ■ Existing Wafer Production Locations see “old” ■ Samsung Electronics Co, Ltd., Korea

- ▶ **Product identification** Traceability is assured via SP number, wafer lot number and date code (refer to 3_cip23163_a)

- ▶ **Impact of change** **NO** impact on electrical performance. Quality and reliability verified by qualification. There is no change in form, fit and function

- ▶ **Attachments**
“pcn_2023-163-A_[customer-no].pdf” affected product list
2_cip23163_a qualification report
3_cip23163_a customer information package
4_cip23163_a new SP number list

- ▶ **Time schedule**

<ul style="list-style-type: none"> ■ Final qualification report 	available
<ul style="list-style-type: none"> ■ First samples available 	on request
<ul style="list-style-type: none"> ■ Intended start of delivery 	2024-02-15 (or earlier based on customer approval)

If you have any questions, please do not hesitate to contact your local sales office.